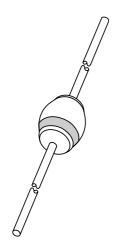
DISCRETE SEMICONDUCTORS

DATA SHEET



BYV27 series Ultra fast low-loss controlled avalanche rectifiers

Product specification
Supersedes data of 1996 Oct 02
File under Discrete Semiconductors, SC01





Ultra fast low-loss controlled avalanche rectifiers

BYV27 series

FEATURES

- · Glass passivated
- High maximum operating temperature
- · Low leakage current
- Excellent stability
- Guaranteed avalanche energy absorption capability
- Available in ammo-pack.

DESCRIPTION

Rugged glass SOD57 package, using a high temperature alloyed construction.

This package is hermetically sealed and fatigue free as coefficients of expansion of all used parts are matched.



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{RRM}	repetitive peak reverse voltage				
	BYV27-50		_	50	V
	BYV27-100		_	100	V
	BYV27-150		_	150	V
	BYV27-200		_	200	V
	BYV27-300		_	300	V
	BYV27-400		_	400	V
	BYV27-500		_	500	V
	BYV27-600		_	600	V
V _R	continuous reverse voltage				
	BYV27-50		_	50	V
	BYV27-100		_	100	V
	BYV27-150		_	150	V
	BYV27-200		_	200	V
	BYV27-300		_	300	V
	BYV27-400		_	400	V
	BYV27-500		_	500	V
	BYV27-600		_	600	V
I _{F(AV)}	average forward current	T _{tp} = 85 °C; lead length = 10 mm;			
	BYV27-50 to 200	see Figs 2, 3 and 4;	_	2.0	Α
	BYV27-300 and 400	averaged over any 20 ms period; see also Figs 14, 15 and 16	_	1.9	Α
	BYV27-500 and 600	see also rigs 14, 15 and 16	_	1.6	Α
I _{F(AV)}	average forward current	T _{amb} = 60 °C; printed-circuit board			
	BYV27-50 to 200	mounting (see Fig. 25);	_	1.30	Α
	BYV27-300 and 400	see Figs 5, 6 and 7; averaged over any 20 ms period;	_	1.25	Α
	BYV27-500 and 600	see also Figs 14, 15 and 16	_	1.10	Α

Ultra fast low-loss controlled avalanche rectifiers

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SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{FRM}	repetitive peak forward current	T _{tp} = 85 °C; see Figs 8, 9 and 10			
	BYV27-50 to 400		_	20	Α
	BYV27-500 and 600		_	16	Α
I _{FRM}	repetitive peak forward current	T _{amb} = 60 °C;			
	BYV27-50 to 200	see Figs 11, 12 and 13	_	14	Α
	BYV27-300 and 400		_	13	Α
	BYV27-500 and 600		_	11	Α
I _{FSM}	non-repetitive peak forward current	t = 10 ms half sine wave;			
	BYV27-50 to 400	$T_j = T_{j \text{ max}}$ prior to surge;	_	50	Α
	BYV27-500 and 600	$V_R = V_{RRMmax}$	_	40	Α
E _{RSM}	non-repetitive peak reverse	$L = 120 \text{ mH}$; $T_j = T_{j \text{ max}}$ prior to	_	20	mJ
	avalanche energy	surge; inductive load switched off			
T _{stg}	storage temperature		-65	+175	°C
T _j	junction temperature	see Fig. 17	-65	+175	°C

ELECTRICAL CHARACTERISTICS

 $T_j = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	forward voltage	$I_F = 2 A; T_j = T_{j \text{ max}};$				
	BYV27-50 to 200	see Figs 18, 19 and 20	_	_	0.78	V
	BYV27-300 and 400		_	_	0.82	V
	BYV27-500 and 600		_	_	1.00	V
V _F	forward voltage	I _F = 2 A;				
	BYV27-50 to 200	see Figs 18, 19 and 20	_	_	0.98	V
	BYV27-300 and 400		_	_	1.05	V
	BYV27-500 and 600		_	_	1.25	V
V _{(BR)R}	reverse avalanche breakdown voltage	I _R = 0.1 mA				
	BYV27-50		55	_	_	V
	BYV27-100		110	_	_	V
	BYV27-150		165	_	_	V
	BYV27-200		220	_	_	V
	BYV27-300		330	_	_	V
	BYV27-400		440	_	_	V
	BYV27-500		560	_	_	V
	BYV27-600		675	_	_	V
I _R	reverse current	V _R = V _{RRMmax} ; see Fig. 21	_	_	5	μΑ
		$V_R = V_{RRMmax};$ $T_j = 165 ^{\circ}C;$ see Fig. 21	_	_	150	μΑ

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t _{rr}	reverse recovery time	when switched from				
	BYV27-50 to 200	$I_F = 0.5 \text{ A to } I_R = 1 \text{ A};$	_	_	25	ns
	BYV27-300 to 600	measured at $I_R = 0.25 A$; see Fig. 27	-	-	50	ns
C _d	diode capacitance	$f = 1 \text{ MHz}; V_R = 0;$				
	BYV27-50 to 200	see Figs 22, 23 and 24	_	100	_	pF
	BYV27-300 and 400		_	80	_	pF
	BYV27-500 and 600		-	65	_	pF
dl _R	maximum slope of reverse recovery	when switched from	_	_	4	A/μs
$\frac{ dI_R }{dt}$	current	$I_F = 1 \text{ A to } V_R \ge 30 \text{ V}$				
' '		and $dI_F/dt = -1 A/\mu s$;				
		see Fig. 26				

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-tp}	thermal resistance from junction to tie-point	lead length = 10 mm	46	K/W
R _{th j-a}	thermal resistance from junction to ambient	note 1	100	K/W

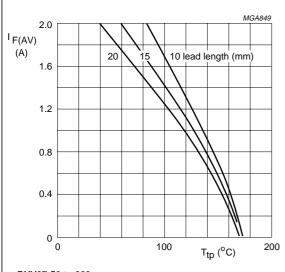
Note

1. Device mounted on an epoxy-glass printed-circuit board, 1.5 mm thick; thickness of Cu-layer ≥40 μm, see Fig. 25. For more information please refer to the *'General Part of Handbook SC01'*.

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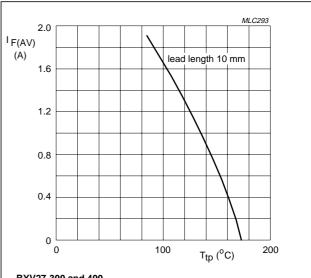
GRAPHICAL DATA



BYV27-50 to 200

a = 1.42; $V_R = V_{RRMmax}$; $\delta = 0.5$. Switched mode application.

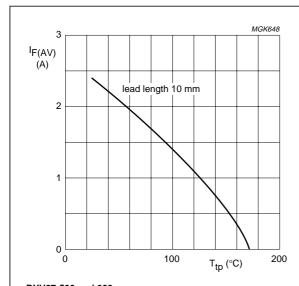
Maximum permissible average forward Fig.2 current as a function of tie-point temperature (including losses due to reverse leakage).



BYV27-300 and 400

 $a=1.42;\,V_R=V_{RRMmax};\,\delta=0.5.$ Switched mode application.

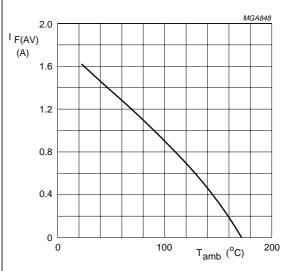
Maximum permissible average forward Fig.3 current as a function of tie-point temperature (including losses due to reverse leakage).



BYV27-500 and 600

a = 1.42; $V_R = V_{RRMmax}$; $\delta = 0.5$. Switched mode application.

Maximum permissible average forward Fig.4 current as a function of tie-point temperature (including losses due to reverse leakage).



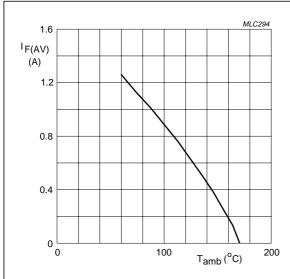
BYV27-50 to 200

a = 1.42; $V_R = V_{RRMmax}$; $\delta = 0.5$. Device mounted as shown in Fig. 25. Switched mode application.

Maximum permissible average forward current as a function of ambient temperature (including losses due to reverse leakage).

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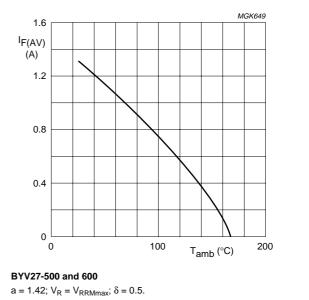
BYV27-300 and 400

a = 1.42; $V_R = V_{RRMmax}$; $\delta = 0.5$.

Device mounted as shown in Fig. 25.

Switched mode application.

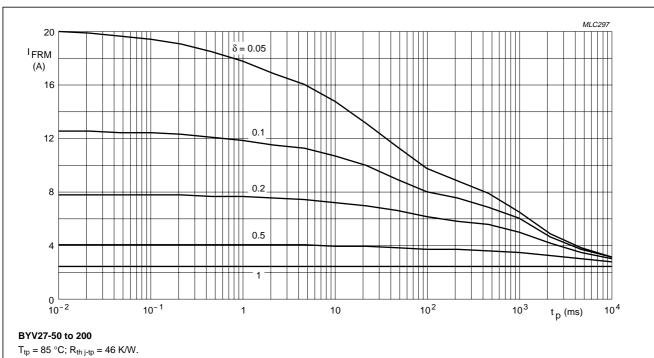
Fig.6 Maximum permissible average forward current as a function of ambient temperature (including losses due to reverse leakage).



Device mounted as shown in Fig. 25.

Switched mode application.

Fig.7 Maximum permissible average forward current as a function of ambient temperature (including losses due to reverse leakage).

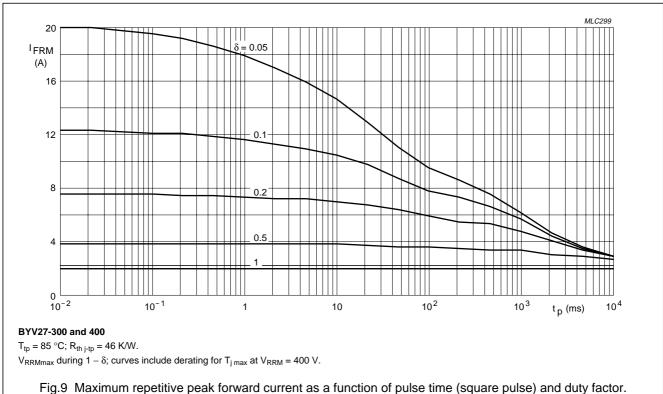


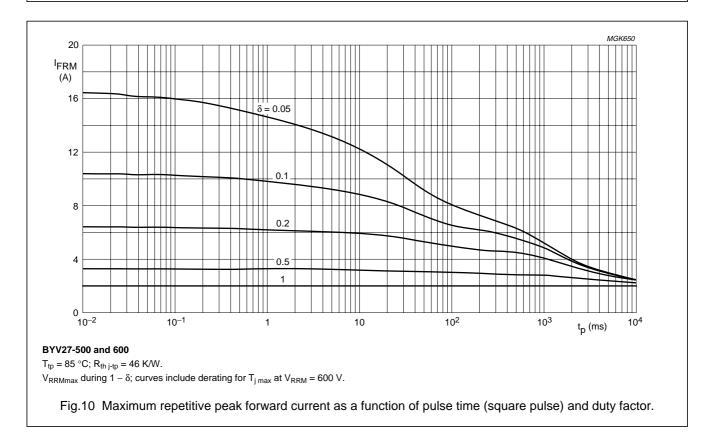
 V_{RRMmax} during 1 – δ ; curves include derating for $T_{j\,max}$ at V_{RRM} = 200 V.

Fig.8 Maximum repetitive peak forward current as a function of pulse time (square pulse) and duty factor.

Ultra fast low-loss controlled avalanche rectifiers

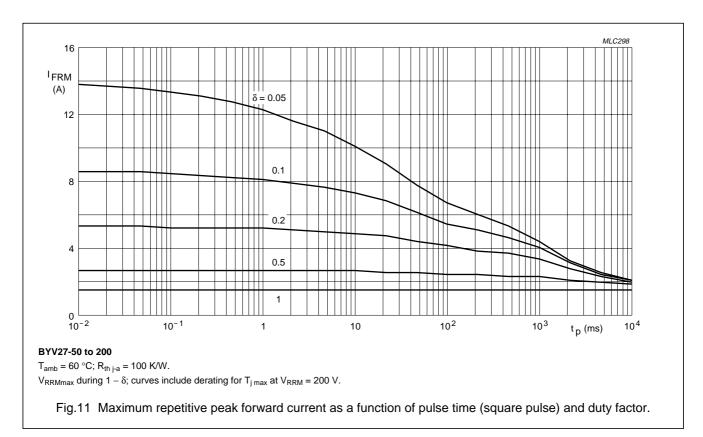
BYV27 series





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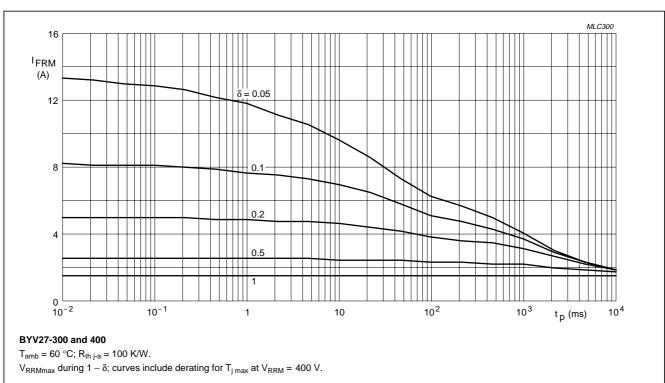


Fig.12 Maximum repetitive peak forward current as a function of pulse time (square pulse) and duty factor.

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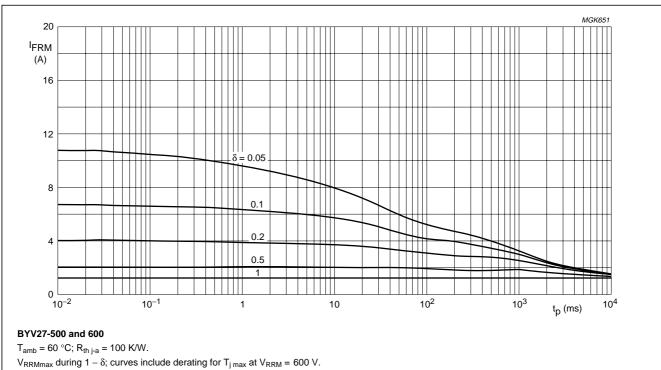


Fig.13 Maximum repetitive peak forward current as a function of pulse time (square pulse) and duty factor.

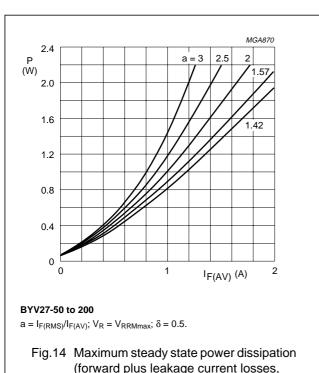
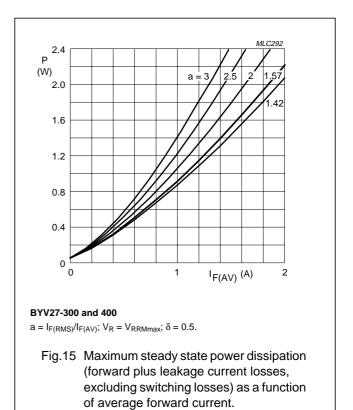


Fig.14 Maximum steady state power dissipation (forward plus leakage current losses, excluding switching losses) as a function of average forward current.



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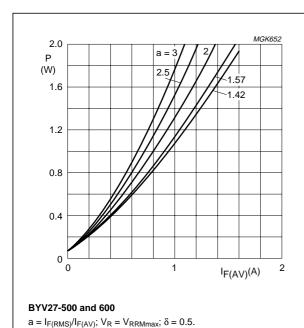


Fig.16 Maximum steady state power dissipation (forward plus leakage current losses, excluding switching losses) as a function of average forward current.

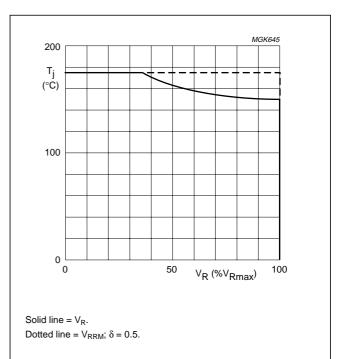
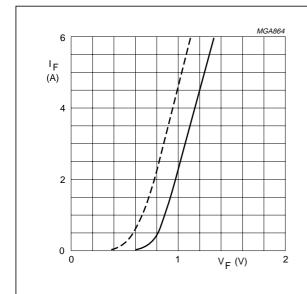


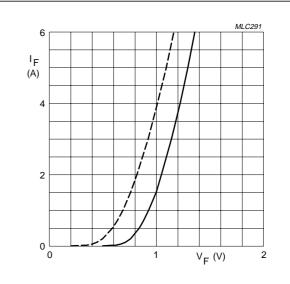
Fig.17 Maximum permissible junction temperature as a function of maximum reverse voltage percentage.



BYV27-50 to 200

Dotted line: $T_j = 175$ °C. Solid line: $T_j = 25$ °C.

Fig.18 Forward current as a function of forward voltage; maximum values.



BYV27-300 and 400

Dotted line: $T_j = 175$ °C. Solid line: $T_j = 25$ °C.

Fig.19 Forward current as a function of forward voltage; maximum values.

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BYV27 series

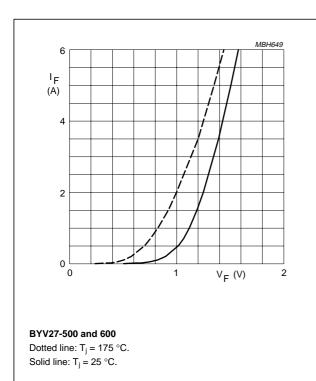
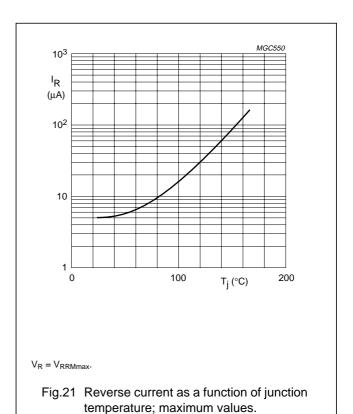


Fig.20 Forward current as a function of forward voltage; maximum values.



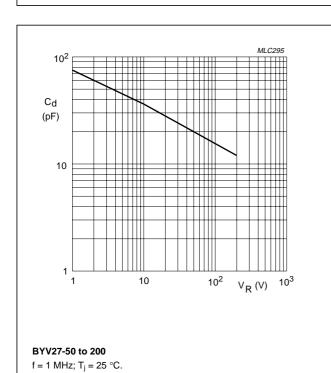
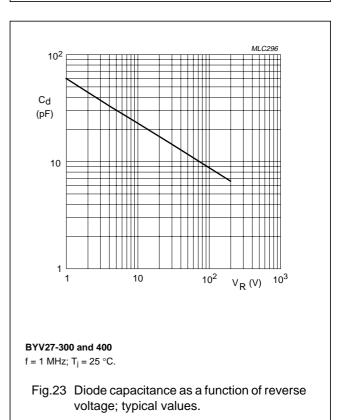


Fig.22 Diode capacitance as a function of reverse voltage; typical values.

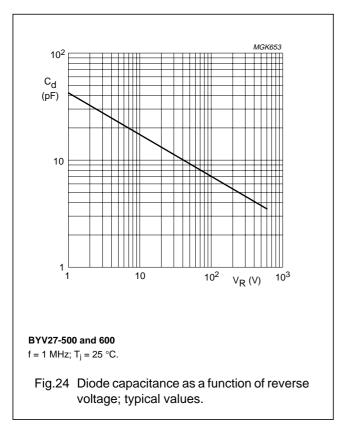


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50 Dimensions in mm.

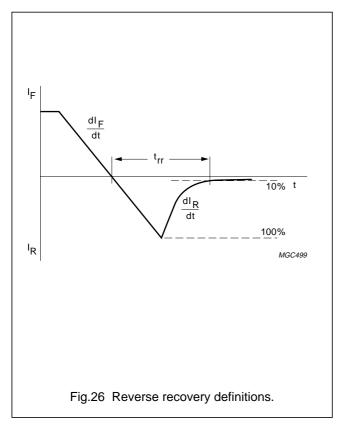
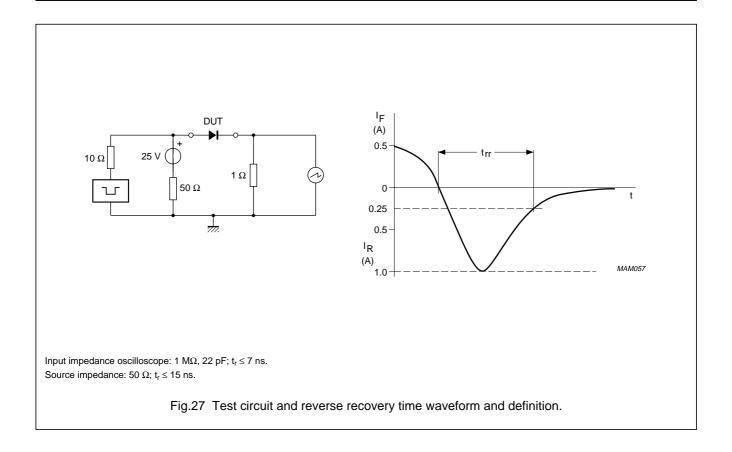


Fig.25 Device mounted on a printed-circuit board.

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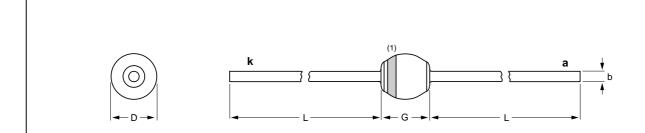
Ultra fast low-loss controlled avalanche rectifiers

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PACKAGE OUTLINE

Hermetically sealed glass package; axial leaded; 2 leads

SOD57



DIMENSIONS (mm are the original dimensions)

UNIT	b max.	D max.	G max.	L min.
mm	0.81	3.81	4.57	28

0 2.5 5 mm scale

Note

1. The marking band indicates the cathode.

OUTLINE		REFERENCES		EUROPEAN ISSUE DAT	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOD57						97-10-14

DEFINITIONS

Data Sheet Status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				

Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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Printed in The Netherlands 117027/1200/04/pp16 Date of release: 1997 Nov 24 Document order number: 9397 750 02663

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